

International  
**IR** Rectifier  
 HEXFET® Power MOSFET

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Lead-Free

**Description**

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

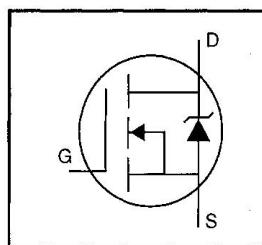
The TO-247 package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220 devices. The TO-247 is similar but superior to the earlier TO-218 package because of its isolated mounting hole. It also provides greater creepage distance between pins to meet the requirements of most safety specifications.

**Absolute Maximum Ratings**

	Parameter	Max.	Units
$I_D @ T_C = 25^\circ\text{C}$	Continuous Drain Current, $V_{GS} @ 10 \text{ V}$	46	A
$I_D @ T_C = 100^\circ\text{C}$	Continuous Drain Current, $V_{GS} @ 10 \text{ V}$	29	
$I_{DM}$	Pulsed Drain Current ①	180	
$P_D @ T_C = 25^\circ\text{C}$	Power Dissipation	280	W
	Linear Derating Factor	2.2	W/°C
$V_{GS}$	Gate-to-Source Voltage	$\pm 20$	V
$E_{AS}$	Single Pulse Avalanche Energy ②	1000	mJ
$I_{AR}$	Avalanche Current ①	46	A
$E_{AR}$	Repetitive Avalanche Energy ①	28	mJ
$dv/dt$	Peak Diode Recovery $dv/dt$ ③	5.0	V/ns
$T_J$ $T_{STG}$	Operating Junction and Storage Temperature Range	-55 to +150	°C
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	
	Mounting Torque, 6-32 or M3 screw	10 lbf-in (1.1 N·m)	

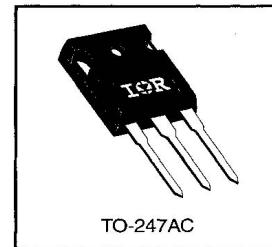
**Thermal Resistance**

	Parameter	Min.	Typ.	Max.	Units
$R_{JC}$	Junction-to-Case	—	—	0.45	°C/W
$R_{CS}$	Case-to-Sink, Flat, Greased Surface	—	0.24	—	
$R_{JA}$	Junction-to-Ambient	—	—	40	



PD-95915  
**IRFP260PbF**

$V_{DSS} = 200\text{V}$   
 $R_{DS(on)} = 0.055\Omega$   
 $I_D = 46\text{A}$



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## Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
$V_{(\text{BR})\text{DSS}}$	Drain-to-Source Breakdown Voltage	200	—	—	V	$V_{\text{GS}}=0\text{V}$ , $I_D=250\mu\text{A}$
$\Delta V_{(\text{BR})\text{DSS}/\Delta T_J}$	Breakdown Voltage Temp. Coefficient	—	0.24	—	V/ $^\circ\text{C}$	Reference to $25^\circ\text{C}$ , $I_D=1\text{mA}$
$R_{\text{DS}(\text{on})}$	Static Drain-to-Source On-Resistance	—	—	0.055	$\Omega$	$V_{\text{GS}}=10\text{V}$ , $I_D=28\text{A}$ ④
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	2.0	—	4.0	V	$V_{\text{DS}}=V_{\text{GS}}$ , $I_D=250\mu\text{A}$
$g_{\text{fs}}$	Forward Transconductance	24	—	—	S	$V_{\text{DS}}=50\text{V}$ , $I_D=28\text{A}$ ④
$I_{\text{DSS}}$	Drain-to-Source Leakage Current	—	—	25	$\mu\text{A}$	$V_{\text{DS}}=200\text{V}$ , $V_{\text{GS}}=0\text{V}$
		—	—	250		$V_{\text{DS}}=160\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=125^\circ\text{C}$
$I_{\text{GSS}}$	Gate-to-Source Forward Leakage	—	—	100	nA	$V_{\text{GS}}=20\text{V}$
	Gate-to-Source Reverse Leakage	—	—	-100		$V_{\text{GS}}=-20\text{V}$
$Q_g$	Total Gate Charge	—	—	230	nC	$I_D=46\text{A}$
$Q_{\text{gs}}$	Gate-to-Source Charge	—	—	42		$V_{\text{DS}}=160\text{V}$
$Q_{\text{gd}}$	Gate-to-Drain ("Miller") Charge	—	—	110		$V_{\text{GS}}=10\text{V}$ See Fig. 6 and 13 ④
$t_{\text{d(on)}}$	Turn-On Delay Time	—	23	—	ns	$V_{\text{DD}}=100\text{V}$ $I_D=46\text{A}$ $R_G=4.3\Omega$ $R_D=2.1\Omega$ See Figure 10 ④
$t_r$	Rise Time	—	120	—		
$t_{\text{d(off)}}$	Turn-Off Delay Time	—	100	—		
$t_f$	Fall Time	—	94	—		
$L_D$	Internal Drain Inductance	—	5.0	—	nH	Between lead, 6 mm (0.25in.) from package and center of die contact
$L_S$	Internal Source Inductance	—	13	—		
$C_{\text{iss}}$	Input Capacitance	—	5200	—	pF	$V_{\text{GS}}=0\text{V}$
$C_{\text{oss}}$	Output Capacitance	—	1200	—		$V_{\text{DS}}=25\text{V}$
$C_{\text{rss}}$	Reverse Transfer Capacitance	—	310	—		$f=1.0\text{MHz}$ See Figure 5

## Source-Drain Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
$I_S$	Continuous Source Current (Body Diode)	—	—	46	A	MOSFET symbol showing the integral reverse p-n junction diode.
$I_{\text{SM}}$	Pulsed Source Current (Body Diode) ①	—	—	180		
$V_{\text{SD}}$	Diode Forward Voltage	—	—	1.8	V	$T_J=25^\circ\text{C}$ , $I_S=46\text{A}$ , $V_{\text{GS}}=0\text{V}$ ④
$t_{rr}$	Reverse Recovery Time	—	390	590	ns	$T_J=25^\circ\text{C}$ , $I_r=46\text{A}$
$Q_{rr}$	Reverse Recovery Charge	—	4.8	7.2	$\mu\text{C}$	$dI/dt=100\text{A}/\mu\text{s}$ ④
$t_{\text{on}}$	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S+L_D$ )				

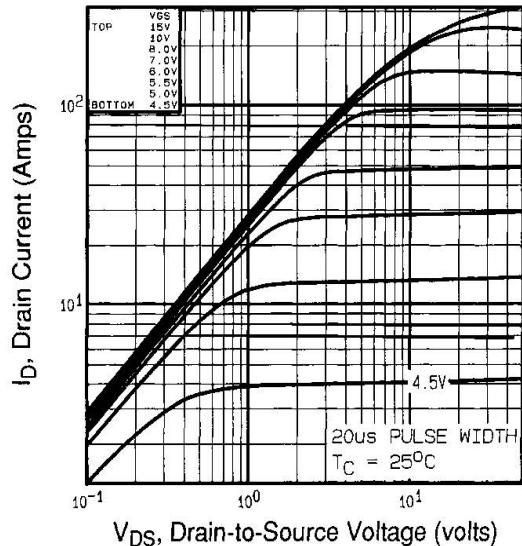
### Notes:

① Repetitive rating; pulse width limited by max. junction temperature (See Figure 11) ③  $I_{\text{SD}} \leq 46\text{A}$ ,  $dI/dt \leq 230\text{A}/\mu\text{s}$ ,  $V_{\text{DD}} \leq V_{(\text{BR})\text{DSS}}$ ,  $T_J \leq 150^\circ\text{C}$

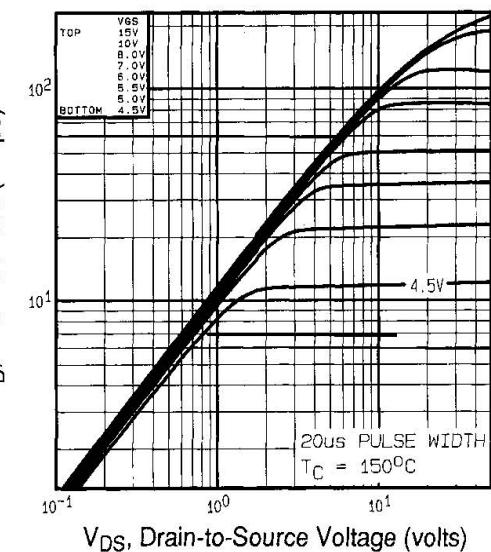
②  $V_{\text{DD}}=50\text{V}$ , starting  $T_J=25^\circ\text{C}$ ,  $L=708\mu\text{H}$   
 $R_G=25\Omega$ ,  $I_{AS}=46\text{A}$  (See Figure 12)

④ Pulse width  $\leq 300\ \mu\text{s}$ ; duty cycle  $\leq 2\%$ .

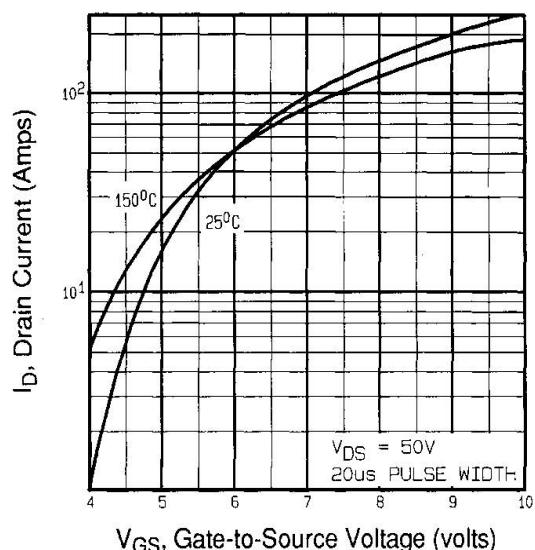
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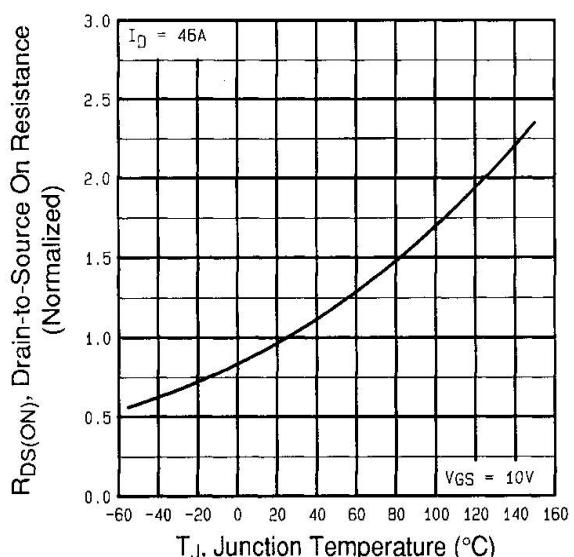
**Fig 1.** Typical Output Characteristics,  
 $T_C = 25^\circ\text{C}$



**Fig 2.** Typical Output Characteristics,  
 $T_C = 150^\circ\text{C}$



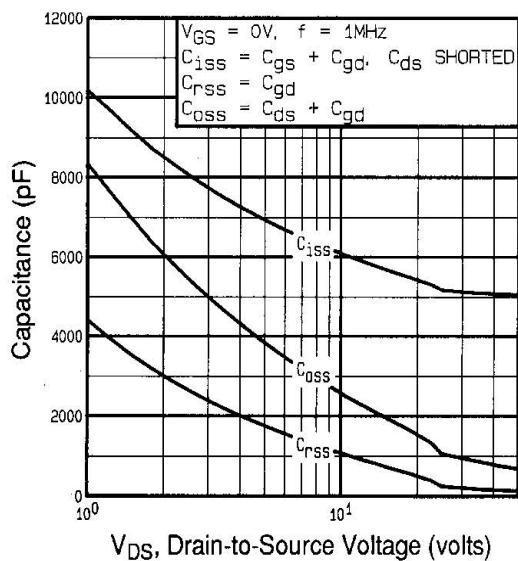
**Fig 3.** Typical Transfer Characteristics



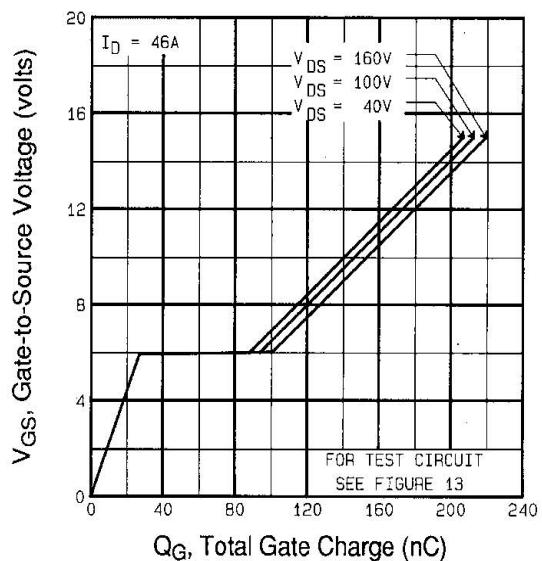
**Fig 4.** Normalized On-Resistance  
Vs. Temperature

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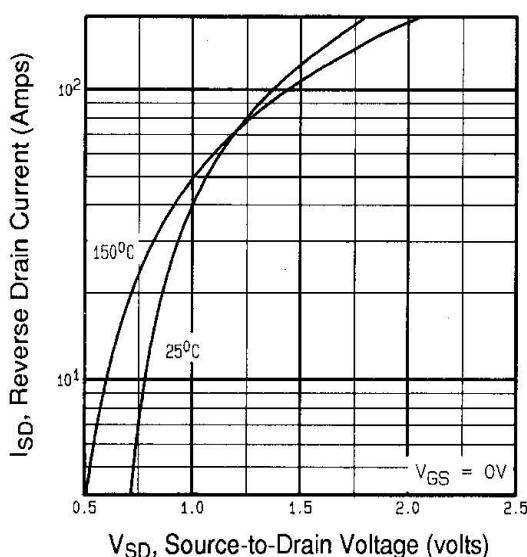
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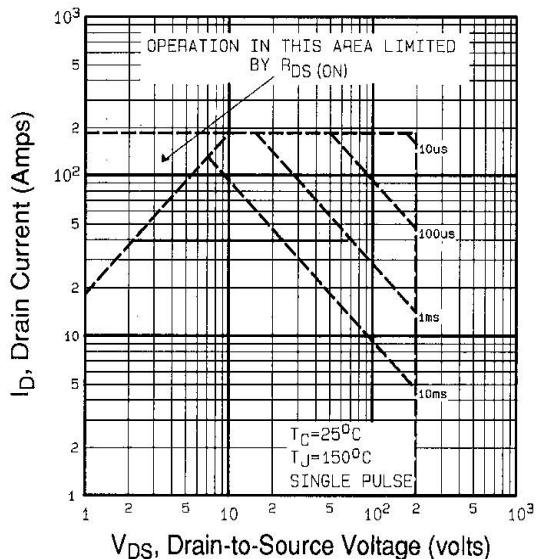
**Fig 5.** Typical Capacitance Vs.  
Drain-to-Source Voltage



**Fig 6.** Typical Gate Charge Vs.  
Gate-to-Source Voltage

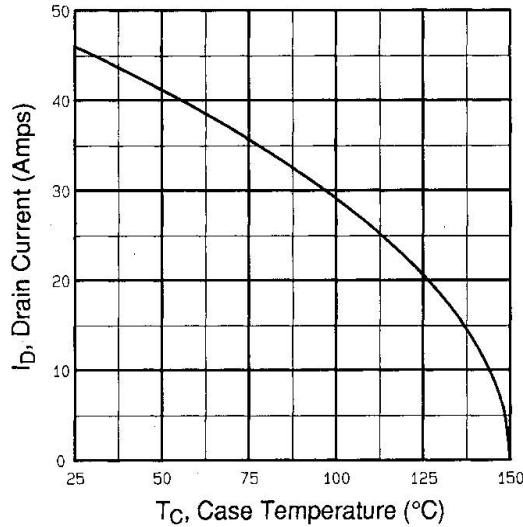


**Fig 7.** Typical Source-Drain Diode  
Forward Voltage



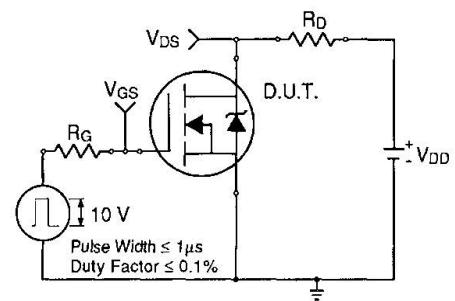
**Fig 8.** Maximum Safe Operating Area

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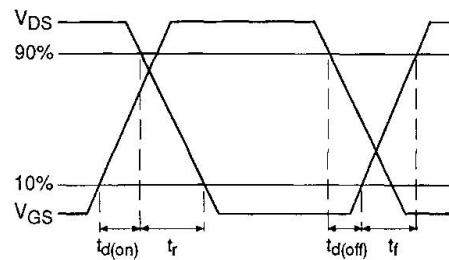


**Fig 9.** Maximum Drain Current Vs.  
Case Temperature

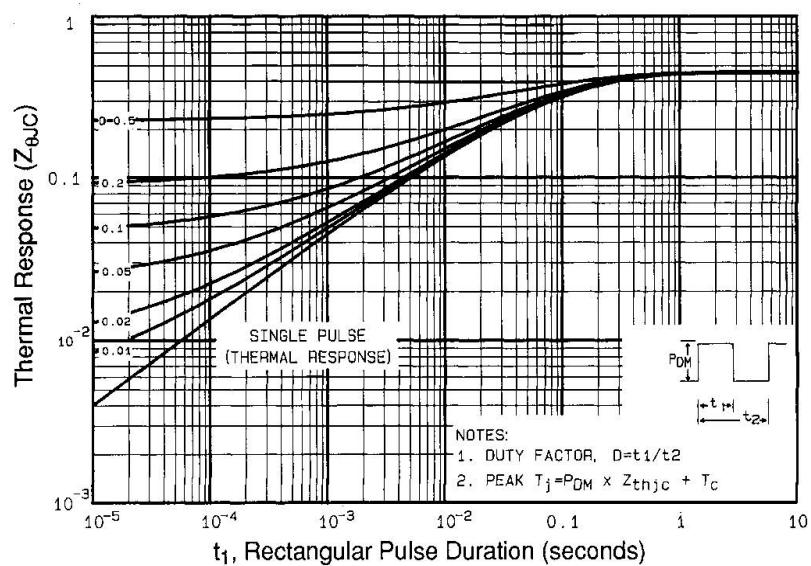
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**Fig 10a.** Switching Time Test Circuit



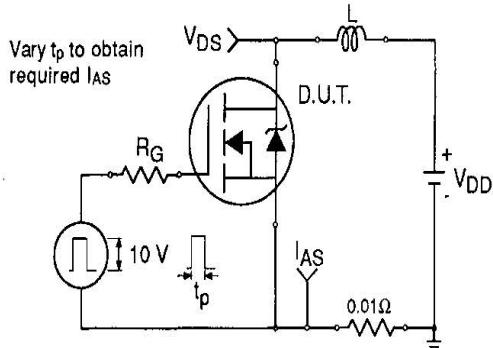
**Fig 10b.** Switching Time Waveforms



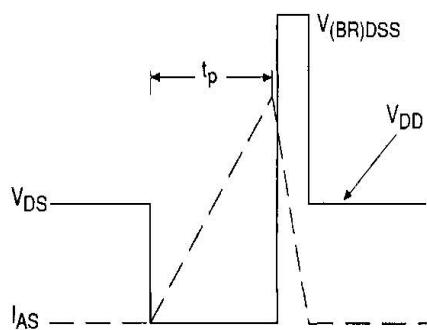
**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Case

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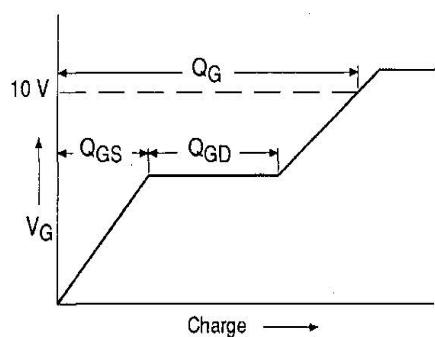
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**Fig 12a.** Unclamped Inductive Test Circuit

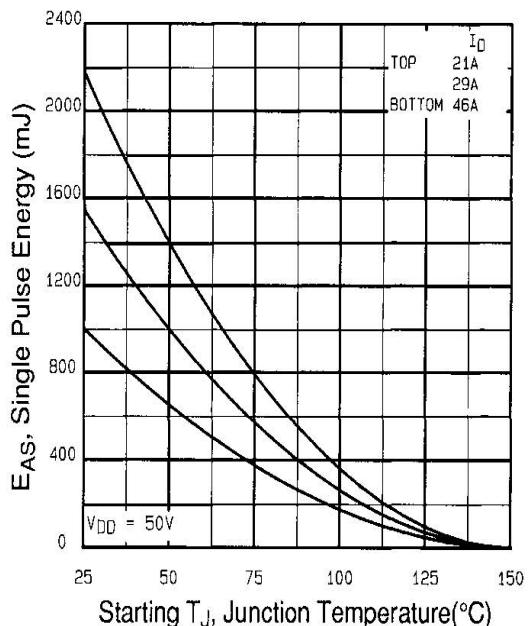


**Fig 12b.** Unclamped Inductive Waveforms

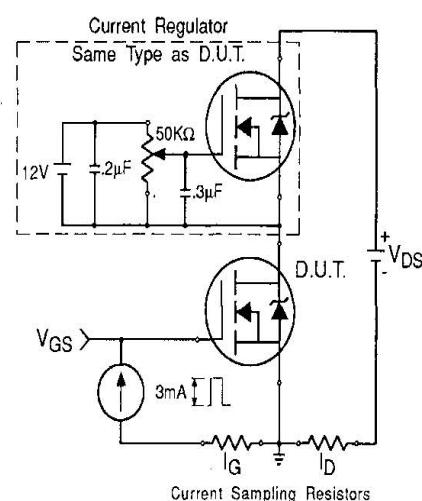


**Fig 13a.** Basic Gate Charge Waveform

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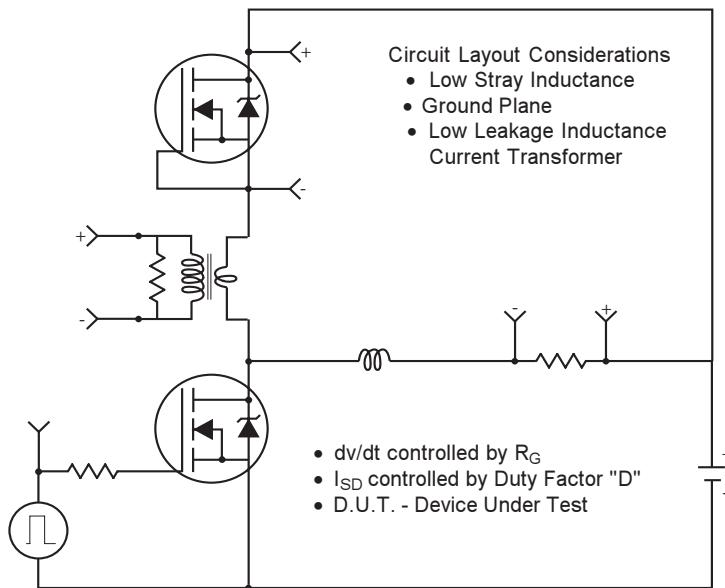
**Fig 12c.** Maximum Avalanche Energy Vs. Drain Current



**Fig 13b.** Gate Charge Test Circuit

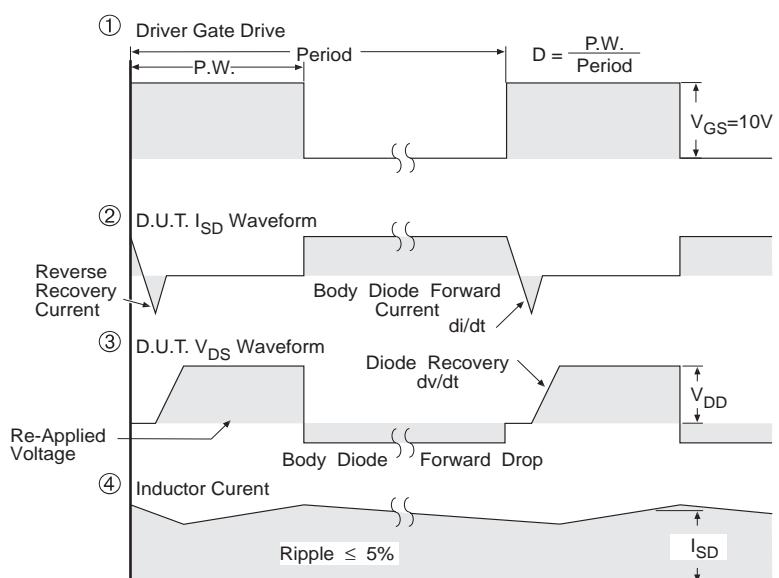
[www.irf.com](http://www.irf.com)

## Peak Diode Recovery dv/dt Test Circuit



\* Reverse Polarity for P-Channel

\*\* Use P-Channel Driver for P-Channel Measurements



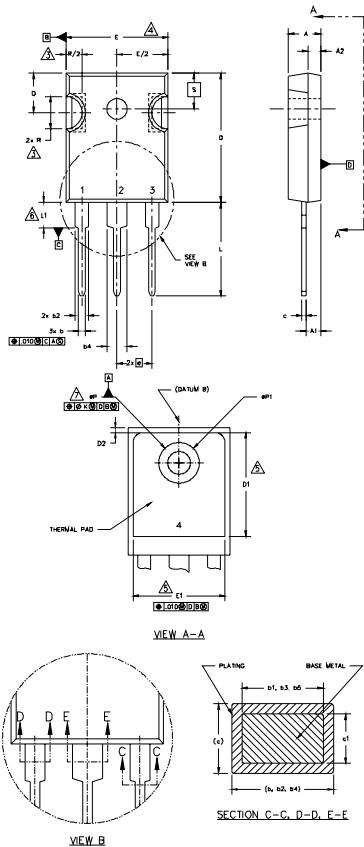
\*\*\*  $V_{GS} = 5.0V$  for Logic Level and 3V Drive Devices

**Fig -14 For N Channel HEXFETS**

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## TO-247AC Package Outline Dimensions are shown in millimeters (inches)



SYMBOL	DIMENSIONS		NOTES	
	INCHES	MILLIMETERS		
	MIN.	MAX.	MIN.	MAX.
A	.183	.209	4.65	5.31
A1	.087	.102	2.21	2.59
A2	.059	.088	1.50	2.49
b	.039	.056	0.99	1.40
b1	.039	.053	0.99	1.35
b2	.065	.094	1.65	2.39
b3	.065	.092	1.65	2.37
b4	.102	.135	2.59	3.43
b5	.102	.133	2.59	3.38
c	.015	.034	0.38	0.86
c1	.015	.030	0.38	0.76
D	.776	.815	19.71	20.70
D1	.515	—	13.08	—
D2	.020	.030	0.51	0.76
E	.602	.625	15.29	15.87
E1	.540	—	15.72	—
e	.215 BSC		5.46 BSC	
gk	.010		2.54	
L	.559	.634	14.20	16.10
L1	.146	.169	3.71	4.29
N	3		7.62 BSC	
oP	.140	.144	3.56	3.66
oP1	—	.275	—	6.98
Q	.209	.224	5.31	5.69
R	.178	.216	4.52	5.49
S	217 BSC		5.51 BSC	

### LEAD ASSIGNMENTS

#### HEXFET

- 1.- GATE
- 2.- DRAIN
- 3.- SOURCE
- 4.- DRAIN

#### IGBTs, CoPACK

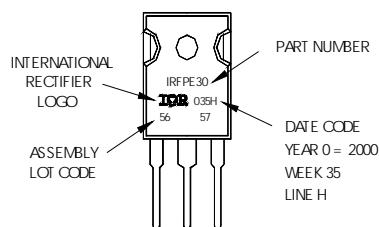
- 1.- GATE
- 2.- COLLECTOR
- 3.- Emitter
- 4.- COLLECTOR

#### DIODES

- 1.- ANODE/OPEN
- 2.- CATHODE
- 3.- ANODE

## TO-247AC Part Marking Information

EXAMPLE: THIS IS AN IRFPE30  
WITH ASSEMBLY  
LOT CODE 5657  
ASSEMBLED ON WV35, 2000  
IN THE ASSEMBLY LINE "H"  
Note: "P" in assembly line  
position indicates "Lead-Free"



Data and specifications subject to change without notice.

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